

**ON Semiconductor®** 

## NDS0605 P-Channel Enhancement Mode Field Effect Transistor

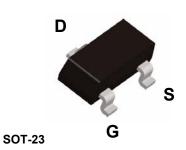
### **General Description**

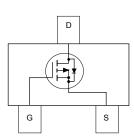
These P-Channel enhancement mode field effect transistors are produced using ON Semiconductor's proprietary, high cell density, DMOS technology. This very high density process has been designed to minimize on-state resistance, provide rugged and reliable performance and fast switching. They can be used, with a minimum of effort, in most applications requiring up to 180mA DC and can deliver current up to 1A.

This product is particularly suited to low voltage applications requiring a low current high side switch.

### Features

- -0.18A, -60V.  $R_{DS(ON)}$  = 5  $\Omega$  @ V<sub>GS</sub> = -10 V
- Voltage controlled p-channel small signal switch
- High density cell design for low  $R_{\text{DS}(\text{ON})}$
- High saturation current





## Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter			Ratings	Units
V <sub>DSS</sub>	Drain-Source	ce Voltage		-60	V
V <sub>GSS</sub>	Gate-Sourc	irce Voltage		±20	V
ID	Drain Current – Continuous (Not		(Note 1)	-0.18	A
	– Pulsed			-1	
P <sub>D</sub>	Maximum Power Dissipation (Note		(Note 1)	0.36	W
	Derate Above 25°C			2.9	mW/°0
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering Purposes, 1/16" from Case for 10 Seconds			300	°C
Therma	l Charac	teristics			
R <sub>0JA</sub>	Thermal Resistance, Junction-to-Ambient (Note 1)		Ambient (Note 1)	350	°C/W
		g and Orderin	g Information	Topo width	Quantity
Device Marking				Tape width	Quantity
65D		NDS0605	7"	8mm	3000 units

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NDS0605

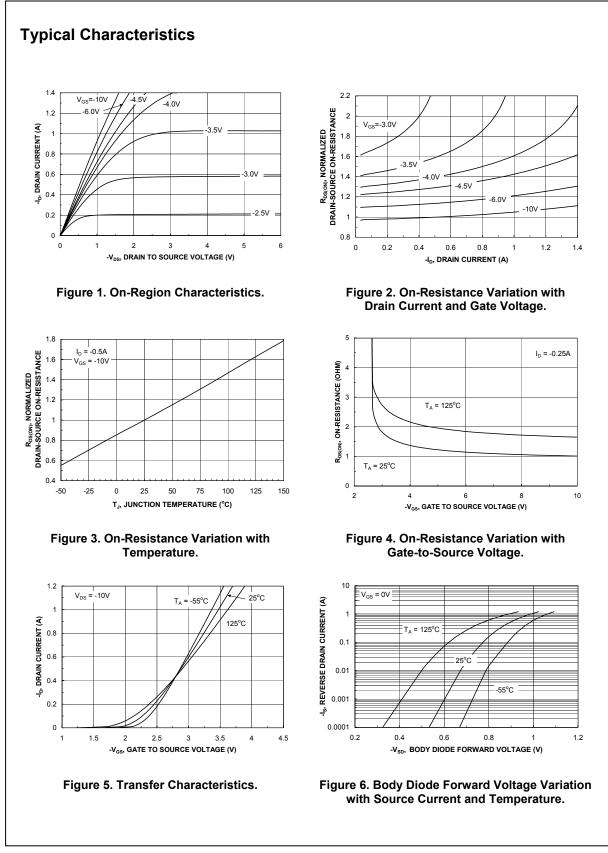
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics				11	
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_D = -10 \mu A$	-60			V
$\Delta BV_{DSS}$ $\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = -10 \ \mu$ A,Referenced to 25°C		-53		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -48 V$ , $V_{GS} = 0 V$			-1	μA
		V <sub>DS</sub> = -48 V,V <sub>GS</sub> = 0 V T <sub>J</sub> = 125°C			-500	μA
I <sub>GSS</sub>	Gate-Body Leakage.	$V_{GS}$ = ±20 V, $V_{DS}$ = 0 V			±100	nA
On Chara	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	-1	-1.7	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D$ = -250 µA,Referenced to 25°C		3		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$V_{GS} = -10 V$ , $I_D = -0.5 A$ $V_{GS} = -4.5 V$ , $I_D = -0.25 A$ $V_{GS} = -10 V$ , $I_D = -0.5 A$ , $T_J=125^{\circ}C$		1.0 1.3 1.7	5.0 7.5 10	Ω
I <sub>D(on)</sub>	On-State Drain Current	V <sub>GS</sub> = -10 V, V <sub>DS</sub> = -10 V	-0.6			А
<b>g</b> <sub>FS</sub>	Forward Transconductance	$V_{DS} = -10V$ , $I_{D} = -0.2 A$	0.07	0.43		S
Dynamic	Characteristics	<u>.</u>				
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -25 V$ , $V_{GS} = 0 V$ ,		79		pF
C <sub>oss</sub>	Output Capacitance	f = 1.0  MHz		10		pF
C <sub>rss</sub>	Reverse Transfer Capacitance	-		4		pF
R <sub>G</sub>	Gate Resistance	V <sub>GS</sub> = -15 mV, f = 1.0 MHz		10		Ω
Switchin	g Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn–On Delay Time	$V_{DD} = -25 V$ , $I_D = -0.2 A$ ,	1	2.5	5	ns
tr	Turn–On Rise Time	$V_{GS} = -10 \text{ V},  R_{GEN} = 6 \Omega$		6.3	12.6	ns
t <sub>d(off)</sub>	Turn–Off Delay Time	-		10	20	ns
t <sub>f</sub>	Turn–Off Fall Time			7.5	15	ns
Qg	Total Gate Charge	$V_{DS} = -48 V$ , $I_D = -0.5 A$ ,		1.8	2.5	nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> = -10 V		0.3		nC
Q <sub>gd</sub>	Gate-Drain Charge			0.4		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings				
Is	Maximum Continuous Drain–Source Diode Forward Current				_ 0.18	А
V <sub>SD</sub>	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$ , $I_{S} = -0.5 A(Note 2)$		-0.8	-1.5	V
t <sub>rr</sub>	Diode Reverse Recovery Time	I <sub>F</sub> = -0.5A		17		nS
Q <sub>rr</sub>	Diode Reverse Recovery Charge	$d_{iF}/d_t = 100 \text{ A}/\mu \text{s}$ (Note 2)		15		nC

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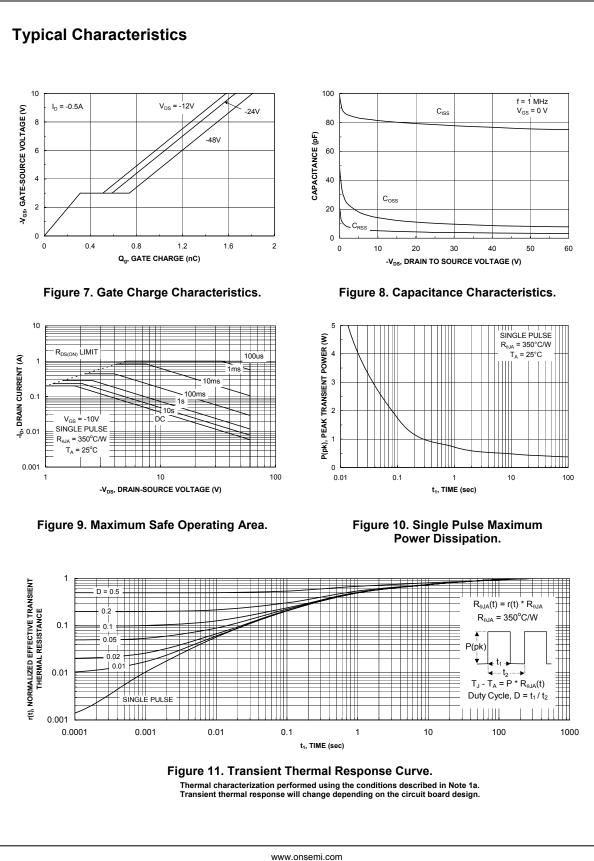
a) 350°C/W when mounted on a minimum pad..

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width  $\leq 300~\mu\text{s},$  Duty Cycle  $\leq 2.0\%$ 



# NDS0605



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